

General Description:

Schottky Barrier Diodes make use of the rectification effect of a metal to silicon barrier. They are ideally suited for high frequency rectification in switching regulators & converters. This device offers a low forward voltage performance in a power surface mount package in applications where size and weight are critical.

Features:

- Compact surface mount package with J-bend leads (SMB).
- 1.5 Watt Power Dissipation package.
- 1.0 Ampere, forward voltage less than 600 mv

Ordering:

- 13 inch reel (330 mm); 12 mm Tape; 3,000 units per reel.

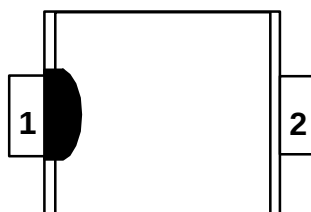
Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Parameter	Value	Units
Storage Temperature	-65 to +150	°C
Maximum Junction Temperature	-65 to +125	°C
Repetitive Peak Reverse Voltage (V_{RRM})	40	V
Average Rectified Forward Current ($T_L = 115^{\circ}\text{C}$)	1.0	A
Average Rectified Forward Current ($T_L = 100^{\circ}\text{C}$)	2.0	A
Surge Non Repetitive Forward Current (Half wave, single phase, 60 Hz)	40	A
Junction to Case for Thermal Resistance ($R_{\theta JL}$)	12	°C/W

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

**SMB Package
(DO-214AA)**

Top Mark: B140

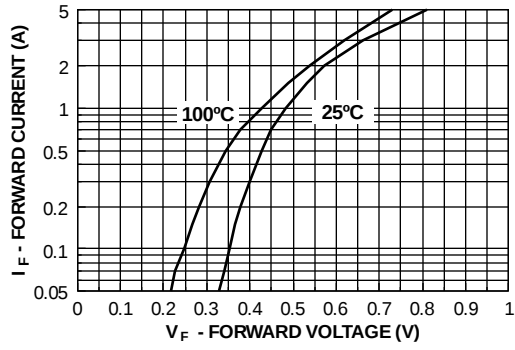


Actual Size

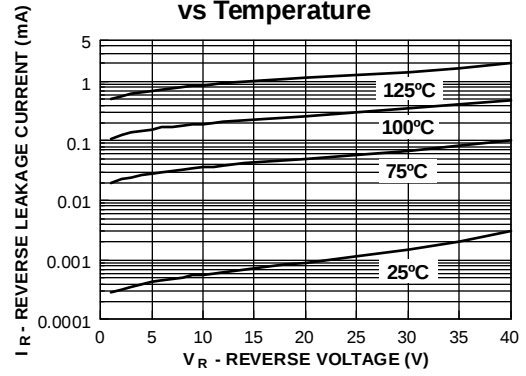
Electrical Characteristics TA = 25°C unless otherwise noted

SYM	CHARACTERISTICS	MIN	MAX	UNITS	TEST CONDITIONS
I_R	Reverse Leakage Current PW 300 us, $\leq 2\%$ Duty Cycle		1.0 10	mA mA	$V_R = 40 \text{ V}; T_j = 25^{\circ}\text{C}$ $V_R = 40 \text{ V}; T_j = 100^{\circ}\text{C}$
V_F	Forward Voltage PW 300 us, $\leq 2\%$ Duty Cycle		550	mV	$I_F = 1.0 \text{ A}; T_j = 25^{\circ}\text{C}$

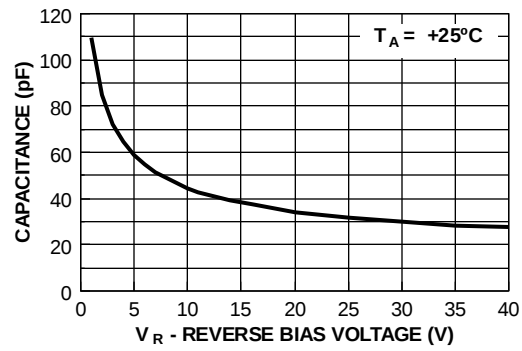
**Forward Voltage
vs Temperature**



**Reverse Leakage Current
vs Temperature**



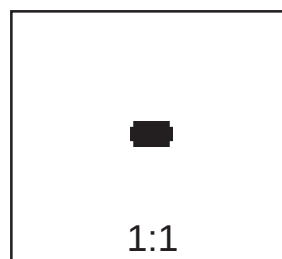
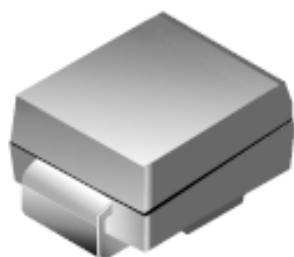
**Capacitance vs.
Reverse Bias Voltage**



SMB/DO-214AA Package Dimensions



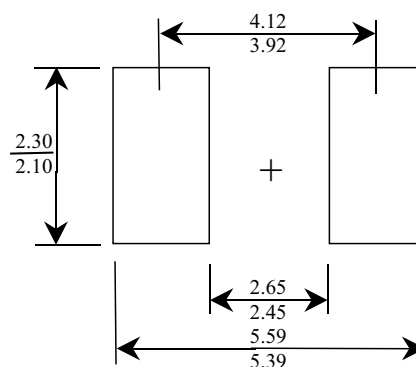
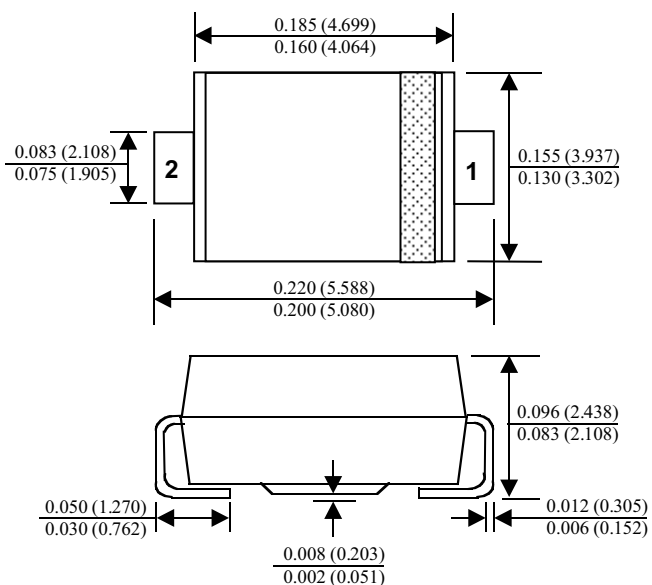
SMB/DO-214AA (FS PKG Code P6)



Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.093



Minimum Recommended
Land Pattern

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